

Press Release

MITI Minister Tengku Zafrul Aziz visits X-FAB Sarawak

Kuching, Sarawak, Malaysia – July 30, 2024

On July 29, [X-FAB Sarawak Sdn. Bhd.](#), a subsidiary of X-FAB Silicon Foundries SE, was honored to host a visit of Malaysia's Minister of Investment, Trade and Industry, YB Senator Tengku Datuk Seri Utama Zafrul Tengku Abdul Aziz and a delegation of approximately 40 members. Tan Sri Dr. Hamid Bugo, Chairman of X-FAB group's Board of Directors was also present to welcome the delegates. During their visit, the Minister was given a tour of the state-of-the-art facilities by Lee Boon Chun, CEO of X-FAB Sarawak. He explained that the Kuching site is the largest and most modern manufacturing facility within the X-FAB group which also runs production sites in Germany, France and the United States.

This visit comes at a significant time as X-FAB Sarawak is currently expanding its capacity. A new building is under construction, which will feature additional cleanroom space essential to meet the strong demand for X-FAB's specialty 200mm CMOS technology, in particular its popular 180 nm automotive processes. Every new car worldwide has on average more than 20 chips made by X-FAB inside.

"In the dynamic landscape of semiconductor manufacturing, it is with immense pride that we showcase the expansion of X-FAB Sarawak. The addition of a new building equipped with cutting-edge cleanroom facilities for our 200mm CMOS technology is a testament to our relentless pursuit of excellence. Hosting the honorable Minister Tengku Zafrul Aziz, along with his delegation, provides us with the unique opportunity to demonstrate our advancements and our unwavering commitment to contributing to the industry's growth. We are not just constructing buildings and expanding capacity; we are building the future for X-FAB's specialty technologies here in Kuching," stated Lee Boon Chun, CEO of X-FAB Sarawak.



The progress of the construction is on schedule, with the equipment move-in planned for the fourth quarter.

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About X-FAB

X-FAB is the leading analog/mixed-signal and MEMS foundry group manufacturing silicon wafers for automotive, industrial, consumer, medical and other applications. Its customers worldwide benefit from the highest quality standards, manufacturing excellence and innovative solutions by using X-FAB's modular CMOS and SOI processes in geometries ranging from 1.0 μm to 110 nm, and its special silicon carbide and MEMS long-lifetime processes. X-FAB's analog-digital integrated circuits (mixed-signal ICs), sensors and micro-electro-mechanical systems (MEMS) are manufactured at six production facilities in Germany, France, Malaysia, and the U.S. X-FAB employs approximately 4,500 people worldwide. Learn more at xfab.com.

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